

8 7 6 5 4 3 2 1

F

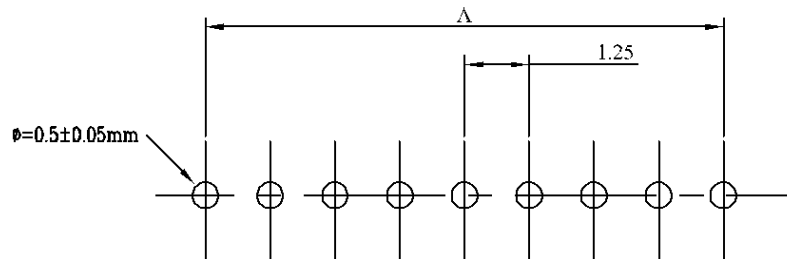
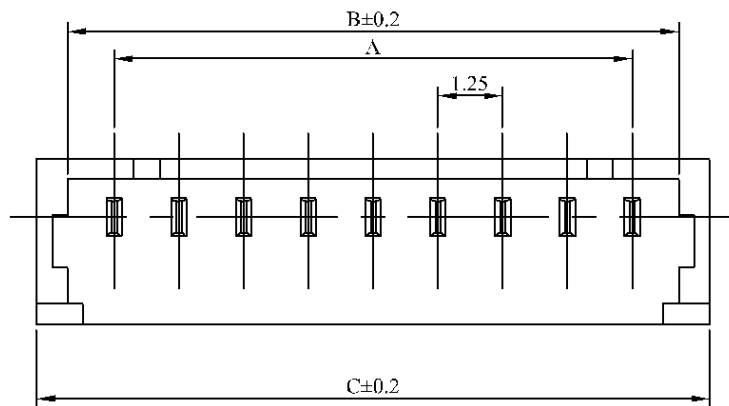
E

D

C

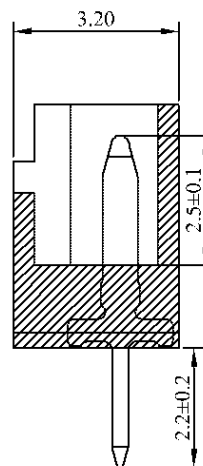
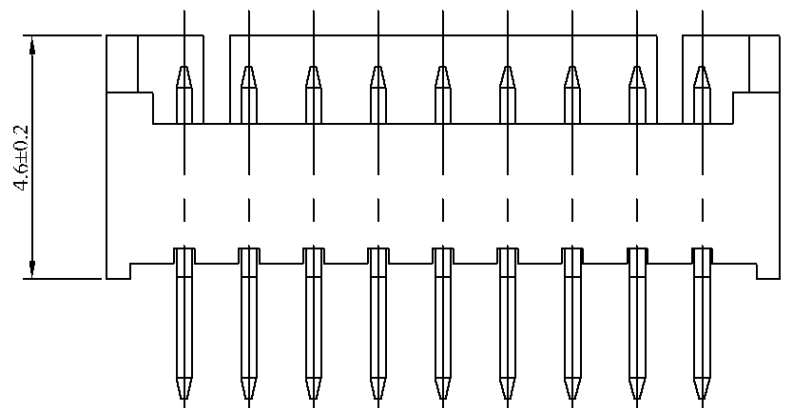
B

A



RECOMMENDED PC BOARD HOLE DIMM.

LOCKING WINDOW:
ONE PLACE FOR 2 AND 3 CKT.
AND TWO PLACES FOR MORE THAN 3 CKT.



MATERIAL:

WAFER:HIGH TEMPERA TURE PLASTIC
NYLON46 UL94V-0
PIN:HIGH STRENGTH BRASS
WITH TIN OVER NICKEL PLATED

SPECIFICATION:

CURRENT RATE: 1 AMP
INSULATION RESISTANCE: 500 M MIN
CONTACT RESISTANCE: 20 M MAX
DIELECTRIC VOLTAGE: 500 V AC FOR ONE MINUTE
OPERATION TEMPERATURE: -25°C ~ +85°C

CKT.	A	B	C
2	1.25	3.15	4.25
3	2.50	4.40	5.50
4	3.75	5.65	6.75
5	5.00	6.90	8.00
6	6.25	8.15	9.25
7	7.50	9.40	10.50
8	8.75	10.65	11.75
9	10.00	11.90	13.00
10	11.25	13.15	14.25
11	12.50	14.40	15.50
12	13.75	15.65	16.75
13	15.00	16.90	18.00
14	16.25	18.15	19.25
15	17.50	19.40	20.50

Revision Record			
LTR	Description	DR	CHK Date
01	修正尺寸及各項數值		99/05/1
02	修正端子尺寸		01/06/18
03	修正端子尺寸及外型		01/07/15
04	修正端子尺寸及外型		02/01/31
05	修正端子外型		02/08/14
General Tolerance: X.XX ± 0.15			
X.X - 0.25			
Unit: mm		Scale: ROM	
DR		CHK	
Erica Tseng		Jasmine Ting	
APPD		C.Y. Liao	

純通有限公司

Name: WIRE TO BOARD 1.25mm WAFER DIP 180°

Drawing No.

Customer Drawing